

#### **Features**

- Small double-end package
- Viewing Angle = ±55°
- High reliability
- Ultra bright Blue
- RoHS compliance

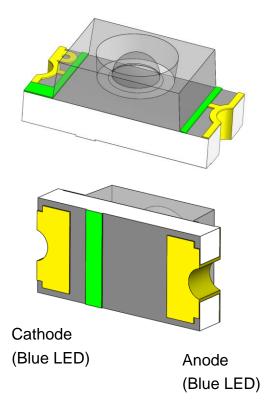
## **Applications**

Blue sensor

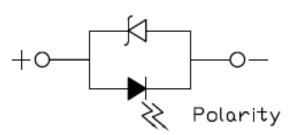
### **Description**

The BP3015Q12-B10 is an InGaN Blue LED housed in a miniature SMD package. The device has a peak wavelength of 465nm LED.

## **Package Outline**



#### **Schematic**





## Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	20	mA	
VR	Reverse Voltage	5	V	
T <sub>opr</sub>	Operating Temperature	-40 ~ +85	°C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	°C	
T <sub>sol</sub>	Soldering Temperature	260	°C	1
PD	Power Dissipation at(or below) 25°C Free Air Temperature	76	mW	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =5mA	45	-	130	mcd	2
λр	Peak Wavelength	I <sub>F</sub> =5mA	-	465	-	nm	
λd	Dominant Wavelength	I <sub>F</sub> =5mA	465	-	475	nm	3
Δλ	Spectral Bandwidth	I <sub>F</sub> =5mA	-	17	-	nm	
θ1/2	Angle of Half Intensity	I <sub>F</sub> =5mA	-	±55	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
\/-	Plus I CD Forward Valtage	I <sub>F</sub> =5mA	2.4	2.65	3.0	V	4
V <sub>F</sub> Blue LED Forward Voltage	Blue LED Forward Vollage	I <sub>F</sub> =20mA	2.6	-	3.8	V	
V <sub>FZ</sub>	Zener LED Forward Voltage	I <sub>FZ</sub> =20mA	0.6	-	1.2	V	

#### Notes:

Soldering time ≤ 5 seconds.

2. Tolerance of Luminous intensity: ±10%

Bin Code	Р	Q
Min	45	71
Max	71	130



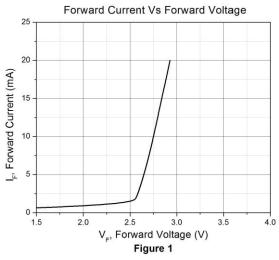
#### 3. Tolerance of Dominant Wavelength: ±1nm

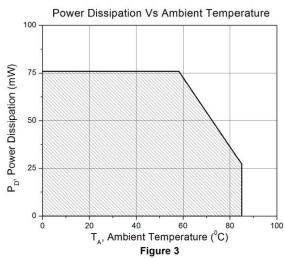
Bin Code	AB	AC
Min	465	470
Max	470	475

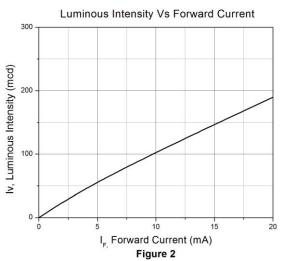
#### 4. Tolerance of Forward Voltage: ±0.1V

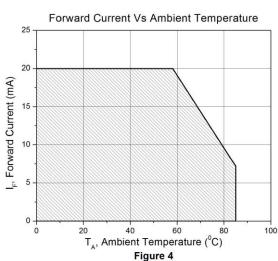
Bin Code	D1	D2	D3
Min	2.4	2.6	2.8
Max	2.6	2.8	3.0

### **Typical Characteristic Curves**

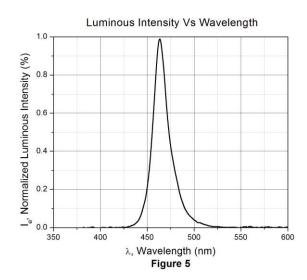




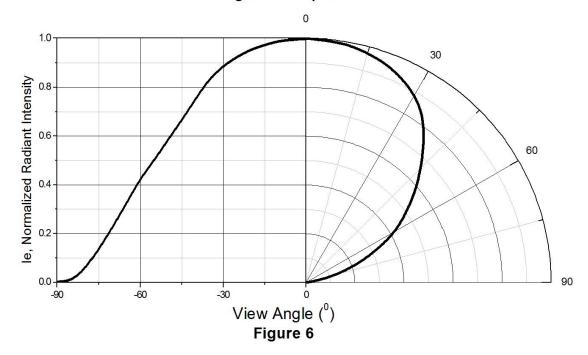






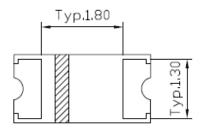


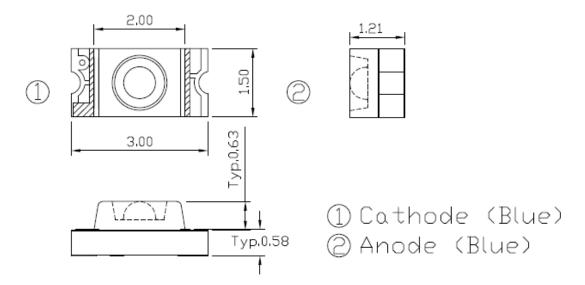
## Angular Displacement



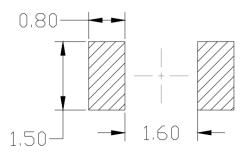


### Package Dimension All dimensions are in mm, unless otherwise stated





### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated

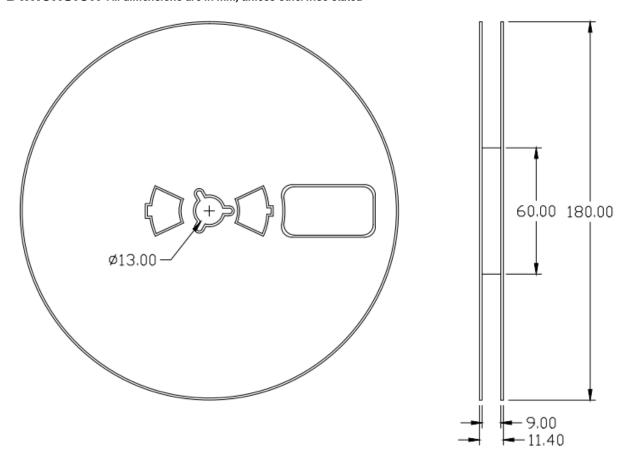


## **Ordering Information**

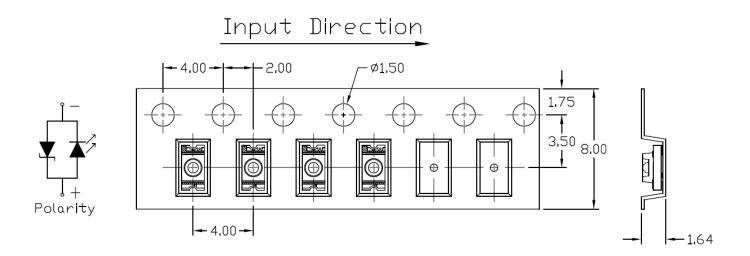
Part Number	Description	Quantity
BP3015Q12-B10	Tape & Reel	3000 pcs



### Reel Dimension All dimensions are in mm, unless otherwise stated

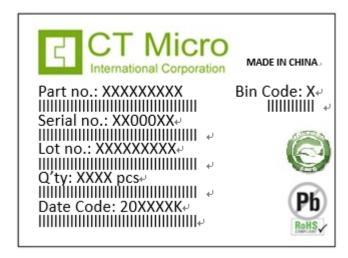


Tape Dimension All dimensions are in mm, unless otherwise stated





### **Label Form Specification**



Part no: CTM Production Number Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

Bin Code: Iv Ranks

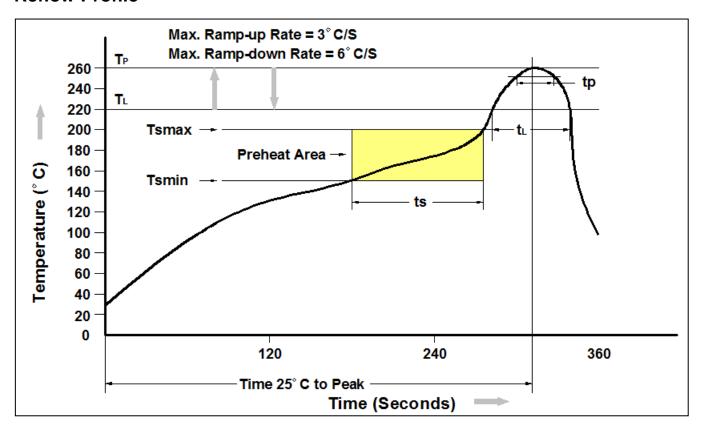
MADE IN CHINA: Production Place

#### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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